Declaration For Patent Application

As a below named inventor, I hereby declare that: My residence, post office address and citizenship are as stated below next to my name, I believe I am the original, first and sole inventor(if only one name is listed below) or an original, first and joint inventor(if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled DETACHABLE AND REPLACEABLE SHOCK DAMPER FOR USE IN STRUCTURES the specification of which (check one) I is attached hereto. was filed on Application Serial No._ and was amended on_ (if applicable) I hereby state that I have reviewed and understand the contents of the above identified specification, including the claim(s), as amended by any amendmemt referred to above. I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a). I hereby claim foreign priority benefits under Title 35, United States Code, \$ 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed: Priority Claimed Prior Foreign Application(s) ☐ Yes ☐ No (Day/Month/Year Filed) (Country) (Number) ☐ Yes ☐ No (Day/Month/Year Filed) (Number) (Country) ☐ Yes ☐ No (Day/Month/Year Filed) (Number) (Country) I hereby claim the benefit under Title 35, United States Code, \$ 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application: PENDING 09/949,574 Sept. 11, 2001 (Filing Date) (Status) (patented, pending, abandoned) (Application Serial No.) (Application Serial No.) (Filing Date) (Status) (patented, pending, abandoned) And I hereby appoint as principal attorneys Morton J. Rosenberg, #26,049; David I. Klein, #33,253; Jun Y. Lee, #40,262; David R. Wood, #53,868; Harry L. Sernaker, #50,595 Rosenberg, Klein & Lee Please direct all communications to the following address: 3458 Ellicott Center Drive, Suite 101 Ellicott City, MD 21043 I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon. Chong-Shien TSAI (TSAI IS FAMILY NAME) Full name of sole or first inventor October 8, 2003 Inventor's signature Alley 10, Lane 86, Sec. 2, nan Kang Rd., Taipei, Taiwan Residence

TAIWAN, R.O.C.

Same as Residence

Citizenship

Post Office Address

Full name of second joint inventor, if any Lap Loi CHUNG (CHUNG IS FAMILY NAME)	
Second inventor's signature Vap Noi Chung	October 9, 2003
Residence4F., No.18, Lane 125, Sec.2, Fu Hsing South Rd., Taipei, Tai	.wan, R.O.C.
Citizenship Taiwan , R.O.C.	
Post Office Address SAME AS RESIDENCE	
Full name of third joint inventor, if any	
Third inventor's signature	Date
Residence	
Citizenship	
Post Office Address	414-121-487-
Full name of fourth joint inventor, if any	
Fourth inventor's signature	Date
Residence	
Citizenship	
Post Office Address	
Full name of fifth joint inventor, if any	
Fifth inventor's signature	
	Date
Residence	
Citizenship	
Post Office Address	